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A novel approach for fabrication of functionally graded W/Cu composites via microwave processing

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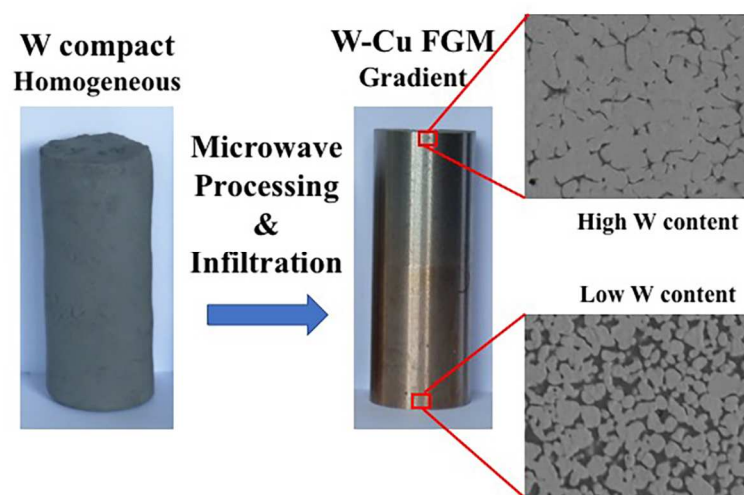
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